

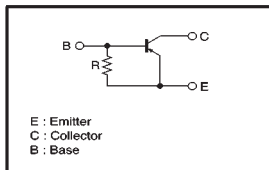
Digital transistors (built-in resistor)

DTA114GE / DTA114GUA / DTA114GKA / DTA114GSA

●Features

- 1) The built-in bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input, and parasitic effects are almost completely eliminated.
- 2) Only the on / off conditions need to be set for operation, making device design easy.
- 3) Higher mounting densities can be achieved.

●Circuit schematic



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	-50	—	—	V	$I_C = -50 \mu A$
Collector-emitter breakdown voltage	BV_{CEO}	-50	—	—	V	$I_C = -1 mA$
Emitter-base breakdown voltage	BV_{EBO}	-5	—	—	V	$I_E = -720 \mu A$
Collector cutoff current	I_{CBO}	—	—	-0.5	μA	$V_{CB} = -50V$
Emitter cutoff current	I_{EBO}	-300	—	-580	μA	$V_{EB} = -4V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	—	-0.3	V	$I_C = -10mA, I_E = -0.5mA$
DC current transfer ratio	h_{FE}	30	—	—	—	$I_C = -5mA, V_{CE} = -5V$
Emitter-base resistance	R	7	10	13	k Ω	—
Transition frequency	f _r	—	250	—	MHz	$V_{CE} = -10V, I_E = 5mA, f = 100MHz$ *

* Transition frequency of the device.

(94S-510-A114G)

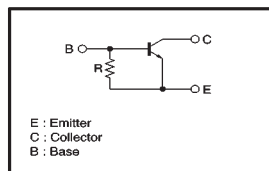
Digital transistors (built-in resistor)

DTC114GUA / DTC114GKA / DTC114GSA

●Features

- 1) The built-in bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input, and parasitic effects are almost completely eliminated.
- 2) Only the on / off conditions need to be set for operation, making device design easy.
- 3) Higher mounting densities can be achieved.

●Circuit schematic



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	50	—	—	V	$I_C = 50 \mu A$
Collector-emitter breakdown voltage	BV_{CEO}	50	—	—	V	$I_C = 1mA$
Emitter-base breakdown voltage	BV_{EBO}	5	—	—	V	$I_E = 720 \mu A$
Collector cutoff current	I_{CBO}	—	—	0.5	μA	$V_{CB} = 50V$
Emitter cutoff current	I_{EBO}	300	—	580	μA	$V_{EB} = 4V$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	—	0.3	V	$I_C = 10mA, I_B = 0.5mA$
DC current transfer ratio	h_{FE}	30	—	—	—	$I_C = 5mA, V_{CE} = 5V$
Emitter-base resistance	R	7	10	13	k Ω	—
Transition frequency	f _r	—	250	—	MHz	$V_{CE} = 10V, I_E = -5mA, f = 100MHz$ *

* Transition frequency of the device.

(94S-629-C114G)

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	-50	V
Collector-emitter voltage	V_{CEO}	-50	V
Emitter-base voltage	V_{EBO}	-5	V
Collector current	I_C	-100	mA
Collector Power dissipation	P_C	150 200 300	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55~+150	°C

●Package, marking, and packaging specifications

Part No.	DTA114GE	DTA114GUA	DTA114GKA	DTA114GSA
Package	EMT3	UMT3	SMT3	SPT
Marking	K14	K14	K14	—
Packaging code	TL	T106	T146	TP
Basic ordering unit (pieces)	3000	3000	3000	5000

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V_{CBO}	50	V
Collector-emitter voltage	V_{CEO}	50	V
Emitter-base voltage	V_{EBO}	5	V
Collector current	I_C	100	mA
Collector Power dissipation	P_C	200 300	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55~+150	°C

●Package, marking, and packaging specifications

Part No.	DTC114GUA	DTC114GKA	DTC114GSA
Package	UMT3	SMT3	SPT
Marking	K24	K24	—
Packaging code	T106	T146	TP
Basic ordering unit (pieces)	3000	3000	5000